# **MOSFET** – N-Channel, UniFET™

500 V, 48 A, 105 m $\Omega$ 

# FDH50N50, FDA50N50

### Description

UniFET MOSFET is ON Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

## Features

- $R_{DS(on)} = 89 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10 \text{ V}, I_D = 24 \text{ A}$
- Low Gate Charge (Typ. 105 nC)
- Low C<sub>rss</sub> (Typ. 45 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- These Devices are Pb-Free and are RoHS Compliant

# Applications

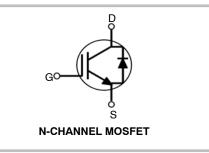
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

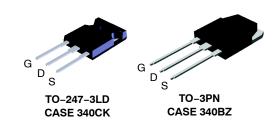


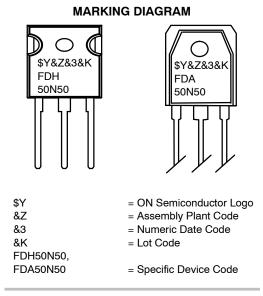
# **ON Semiconductor®**

### www.onsemi.com

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
500 V	105 mΩ @ 10 V	48 A







#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	Parameter		FDH50N50-F133/ FDA50N50	Unit	
V <sub>DSS</sub>	V <sub>DSS</sub> Drain to Source Voltage		500	V	
Ι <sub>D</sub>	Drain Current –	–Continuous (T <sub>C</sub> = 25°C) –Continuous (T <sub>C</sub> = 100°C)		A A	
I <sub>DM</sub>	Drain Current	-Pulsed (Note 1)	192	А	
V <sub>GSS</sub>	Gate-Source Voltage		±20	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1868	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		48	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		62.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		20	V/ns	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C) -Derate Above 25°C	625 5	W W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to + 150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8	" from Case for 5 Second	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. L = 1.46 mH,  $I_{AS}$  = 48 A,  $V_{DD}$  = 50 V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25 °C. 3.  $I_{SD} \le 48$  A, di/dt  $\le 200$  A/ $\mu$ s,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J$  = 25 °C.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FDH50N50-F133	FDH50N50	TO-247-3	Tube	N/A	N/A	30 Units
FDA50N50	FDA50N50	TO-3PN	Tube	N/A	N/A	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FDH50N50-F133/ FDA50N50	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.2	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	500	-	-	V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C	-	0.5	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μΑ
		$V_{DS} = 400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	250	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS}$ = 20 V, $V_{DS}$ = 0 V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARA	CTERISTICS					

VG	GS(th)	Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	3.0	-	5.0	V
R <sub>D</sub>	S(on)	Static Drain-Source On-Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 24 A	-	0.089	0.105	Ω
g	JFS	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 48 A	-	20	-	S

# DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1 MHz	-	4979	6460	pF
C <sub>oss</sub>	Output Capacitance		-	760	1000	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	50	65	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	-	161	-	pF
C <sub>oss</sub> ( <sub>eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	342	-	pF

# SWITCHING CHARACTERISTICS

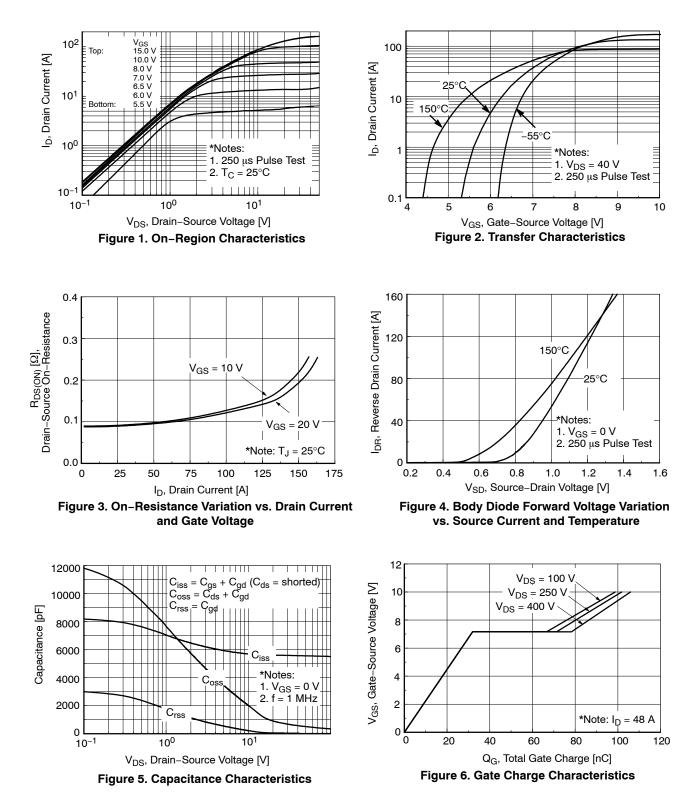
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 48 \text{ A},$	-	105	220	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>G</sub> = 25 Ω (Note 4)	-	360	730	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	225	460	ns
t <sub>f</sub>	Turn-Off Fall Time	]	_	230	470	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 48 A <sub>,</sub> V <sub>GS</sub> = 10 V	-	105	137	nC
Q <sub>gs</sub>	Gate-Source Charge	(Note 4)	_	33	-	nC
Q <sub>gd</sub>	Gate-Drain Charge	]`	-	45	-	nC

#### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

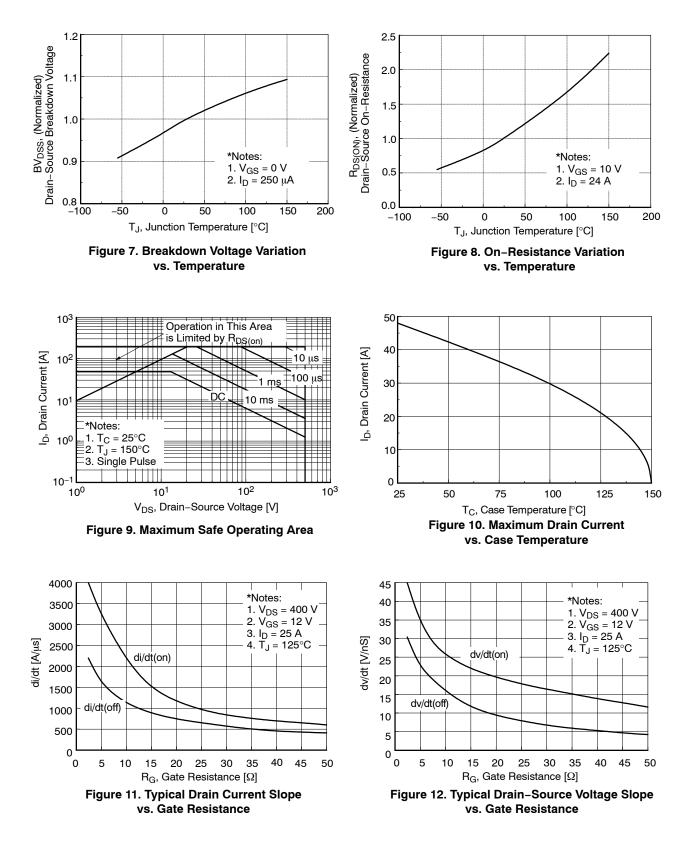
۱ <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	48	А
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	192	А
$V_{SD}$	Source to Drain Diode Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 48 \text{ A}$	-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 48 A,$	-	580	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 Å/µs	-	10	-	μC

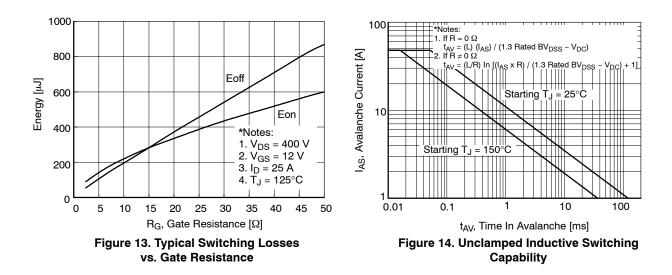
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.Essentially Independent of Operating Temperature Typical Characteristics.

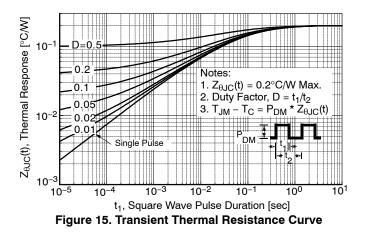
# **TYPICAL CHARACTERISTICS**

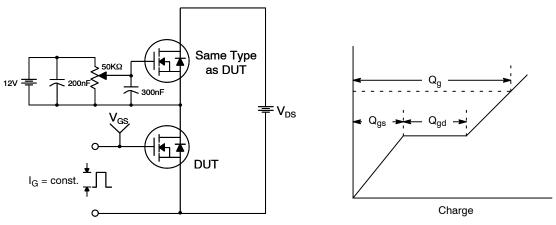


# **TYPICAL CHARACTERISTICS**











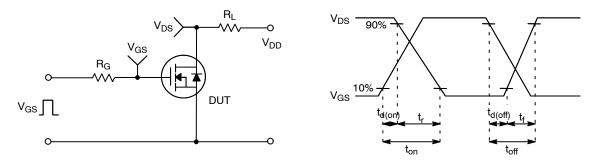


Figure 17. Resistive Switching Test Circuit & Waveforms

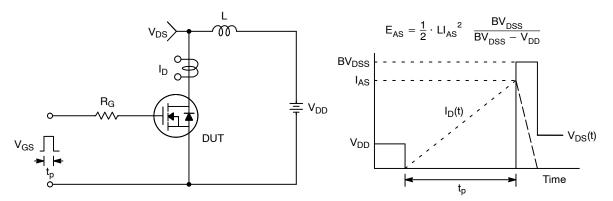


Figure 18. Unclamped Inductive Switching Test Circuit & Waveforms

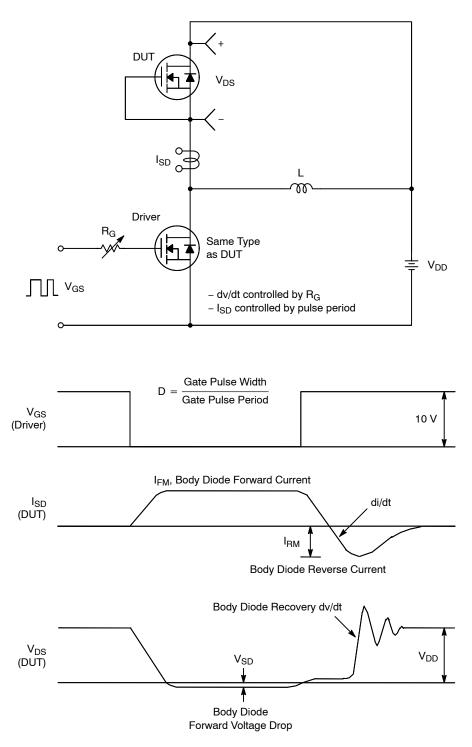
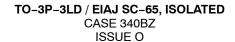


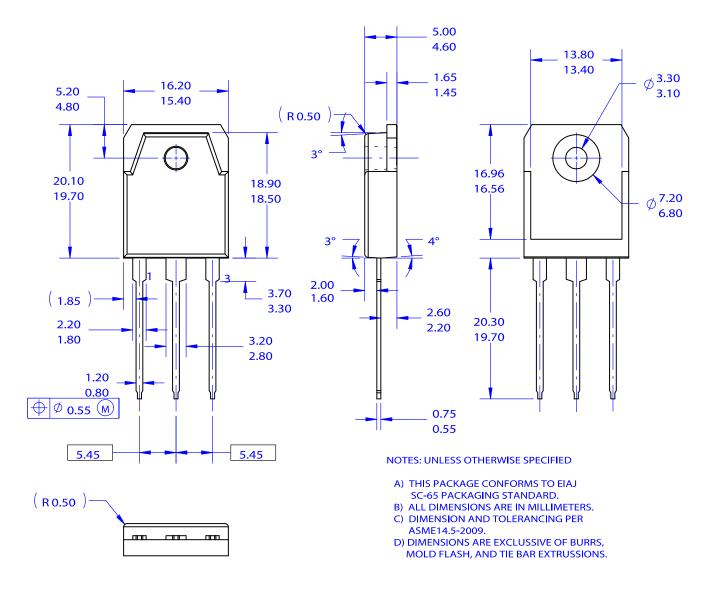
Figure 19. Peak Diode Recovery dv/dt Test Circuit & Waveforms

UniFET is a trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





DATE 31 OCT 2016



DOCUMENT NUMBER:	98AON13862G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION: TO-3P-3LD / EIAJ SC-65, ISOLATED PAGE 1 C						
ON Semiconductor and I are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the						





ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights or others.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative